



20V N-CHANNEL ENHANCEMENT MODE MOSFET

Product Summary

BV _{DSS}	R _{DS(ON)} Max	I _D Max T _A = +25°C
001/	200mΩ @ V _{GS} = 4.5V	1.3A
20V	$280 \text{m}\Omega$ @ $V_{GS} = 2.5V$	1.1A

Features and Benefits

- Low On-Resistance
- Low Input Capacitance
- Fast Switching Speed
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- The DMN2310UWQ is suitable for automotive applications requiring specific change control; this part is AEC-Q101 qualified, PPAP capable, and manufactured in IATF 16949 certified facilities.

https://www.diodes.com/quality/product-definitions/

Description and Applications

This MOSFET has been designed to minimize the on-state resistance (RDS(ON)) yet maintain superior switching performance, making it ideal for high-efficiency power-management applications.

- General purpose interfacing switches
- Power-management functions
- DC-DC converters
- Analog switches

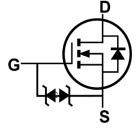
Mechanical Data

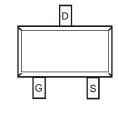
- Package: SOT323
- Package Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections Indicator: See Diagram
- Terminals: Finish Matte Tin Annealed over Copper Leadframe.
 Solderable per MIL-STD-202, Method 208
- Weight: 0.006 grams (Approximate)





SOT323





Top View

Equivalent Circuit

Top View

Ordering Information (Note 4)

Part Number	Paakaga	Packing		
Fait Number	Package	Qty.	Carrier	
DMN2310UWQ-7	SOT323	3,000	Tape & Reel	
DMN2310UWQ-13	SOT323	10,000	Tape & Reel	

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- $4. For packaging details, go to our website at \ https://www.diodes.com/design/support/packaging/diodes-packaging/.$

Marking Information



SOT323

BE4 = Product Type Marking Code $\overline{Y}M$ = Date Code Marking \overline{Y} = Year (ex: L = 2024)

M = Month (ex: 9 = September)

Date Code Kev

Year	2020		2024	2025	2026	2027	2028	2029	2030	2031	2032	2033
Code	Н		L	М	N	Р	R	S	T	U	V	W
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec



Maximum Ratings (@ $T_A = +25$ °C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit		
Drain-Source Voltage	VDSS	20	V		
Gate-Source Voltage	V_{GSS}	±8	V		
Continuous Drain Current (Note 6) Vgs = 4.5V	lo	1.3 1.1	А		
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%	I _{DM}	4.4	Α		
Maximum Body Diode Forward Current (Note 5)			Is	0.6	Α

Thermal Characteristics (@TA = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit
Total Power Dissipation (Note 5)		PD	0.45	W
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	RθJA	275	°C/W
Total Power Dissipation (Note 6)		P _D	0.55	W
Thermal Resistance, Junction to Ambient (Note 6)	Steady State	RθJA	226	°C/W
Operating and Storage Temperature Range		TJ, TSTG	-55 to +150	°C

Electrical Characteristics (@TA = +25°C, unless otherwise specified.)

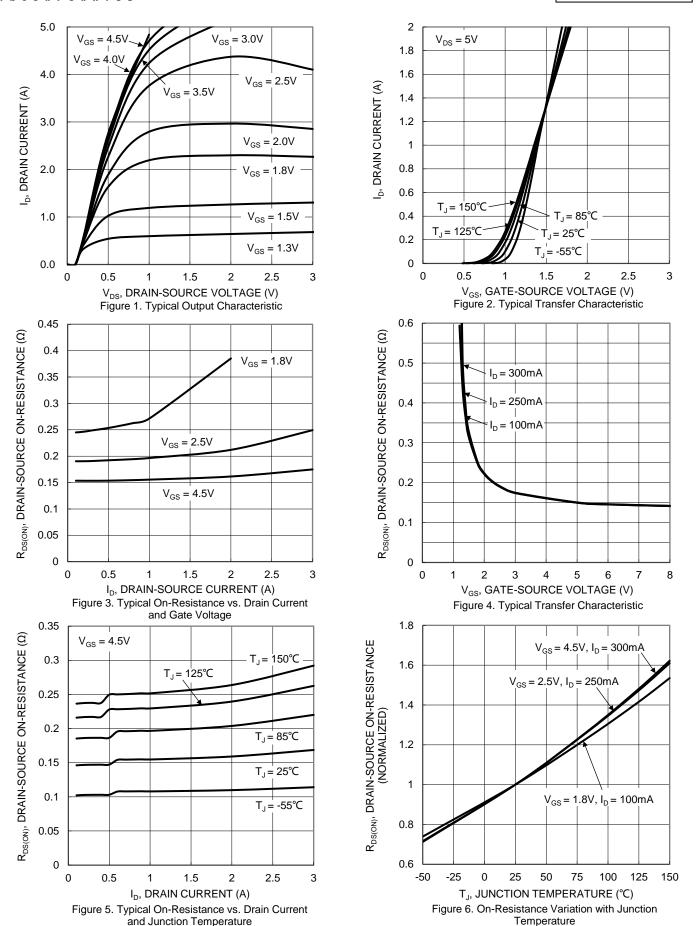
Characteristic	Cumbal	Min	Tym	Max	Unit	Test Condition
	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 7)	1	1	1	1		T
Drain-Source Breakdown Voltage	BVDSS	20	_	_	V	$V_{GS} = 0V, I_{D} = 250\mu A$
Zero Gate Voltage Drain Current @Tc = +25°C	IDSS	_	_	1.0	μΑ	$V_{DS} = 20V$, $V_{GS} = 0V$
Gate-Source Leakage	Igss	_	_	10	μΑ	$V_{GS} = \pm 8V$, $V_{DS} = 0V$
ON CHARACTERISTICS (Note 7)						
Gate Threshold Voltage	VGS(TH)	0.45	_	0.95	V	V _{DS} = V _{GS} , I _D = 250μA
		_	150	200		V _G S = 4.5V, I _D = 300mA
Static Drain-Source On-Resistance	RDS(ON)	_	190	280	mΩ	$V_{GS} = 2.5V, I_{D} = 250mA$
		_	245	380		$V_{GS} = 1.8V, I_{D} = 100mA$
Diode Forward Voltage	V _{SD}	_	0.85	1.2	V	$V_{GS} = 0V, I_{S} = 1A$
DYNAMIC CHARACTERISTICS (Note 8)		•				
Input Capacitance	C _{iss}	_	38	_	pF	
Output Capacitance	Coss	_	10	_	pF	$V_{DS} = 10V, V_{GS} = 0V,$
Reverse Transfer Capacitance	Crss	_	6	_	pF	f = 1.0MHz
Total Gate Charge	Qg	_	0.7	_	nC	1, 15)/)/ 10)/
Gate-Source Charge	Qgs	_	0.1	_	nC	$V_{GS} = 4.5V, V_{DS} = 10V,$
Gate-Drain Charge	Qgd	_	0.1	_	nC	I _D = 1A
Turn-On Delay Time	tD(ON)	_	4.8	_	ns	
Turn-On Rise Time	t _R	_	3	_	ns	V _{DD} = 10V, V _{GS} = 5V,
Turn-Off Delay Time	tD(OFF)	_	181	_	ns	$R_L = 1.7\Omega$, $R_G = 6\Omega$
Turn-Off Fall Time	tF	_	55	_	ns	

Notes:

- 5. Device mounted on FR-4 substrate PC board, with minimum recommended pad layout.6. Device mounted on FR-4 substrate PC board, 2oz copper, with thermal bias to bottom layer 1inch square copper plate.
- 7. Short duration pulse test used to minimize self-heating effect.
- 8. Guaranteed by design. Not subject to product testing.









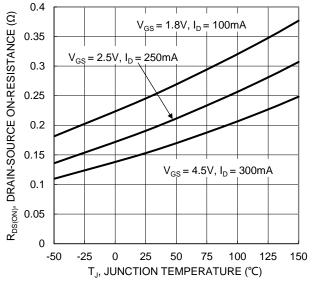
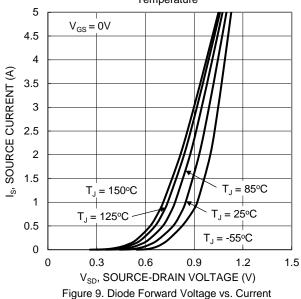


Figure 7. On-Resistance Variation with Junction Temperature



 Q_g (nC) Figure 11. Gate Charge

1

0.5

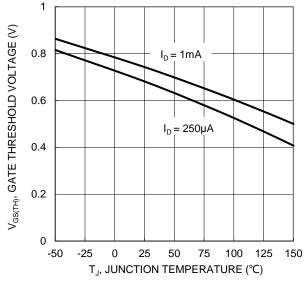
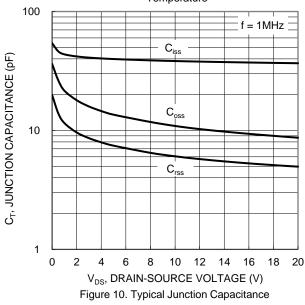


Figure 8. Gate Threshold Variation vs. Junction Temperature



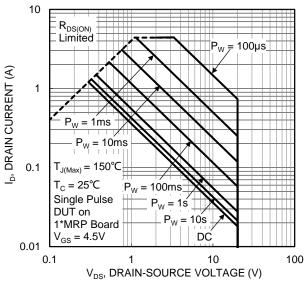


Figure 12. SOA, Safe Operation Area

0

6

1.5



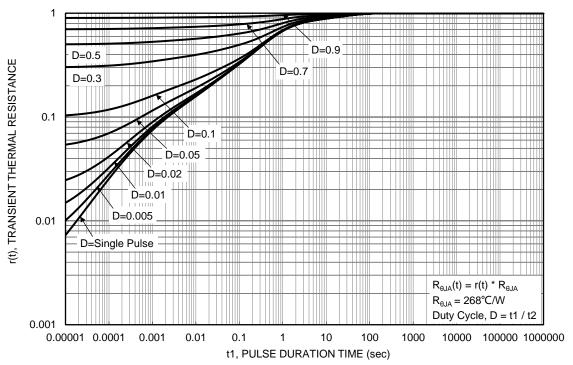


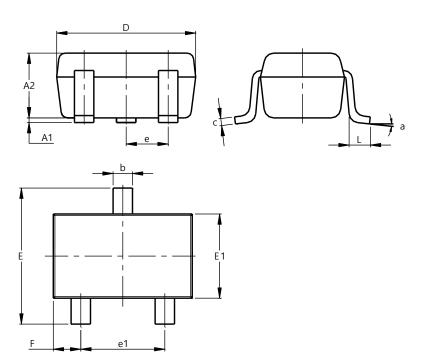
Figure 13. Transient Thermal Resistance



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

SOT323

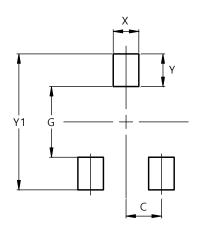


SOT323							
Dim	Min	Max	Тур				
A1	0.00	0.10	0.05				
A2	0.90	1.00	0.95				
b	0.25	0.40	0.30				
С	0.10	0.18	0.11				
D	1.80	2.20	2.15				
Е	2.00	2.20	2.10				
E1	1.15	1.35	1.30				
е	().650 B	SC				
e1	1.20	1.40	1.30				
F	0.375	0.475	0.425				
L	0.25	0.40	0.30				
а	0°	8°	1				
All Dimensions in mm							

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

SOT323



Dimensions	Value
Dilliensions	(in mm)
С	0.650
G	1.300
Х	0.470
Y	0.600
Y1	2.500



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